

SPECIFICATION SHEET

SPECIFICATION SHEET NO.	R0717- YR32K76800S001		
DATE	July 17, 2024		
REVISION	A3	Updated With Most Recent Data	
DESCRIPTION AND MAIN PARAMETRICS	KHz SMD Crystals, L3.2*W1.5*H0.9mm, 2 Pads, YR series 32.76800KHz, ±20ppm, CL 12.5pF Operating Temp. Range -40°C ~+85°C, ESR 70 Kohm Max., Reflow Profile Condition 260 °C Max. Tape/Reel, 3000pcs/Reel, RoHS/RoHS III compliant		
CUSTOMER			
CUSTOMER PART NO.			
CROSS REF. PART NO.			
ORIGINAL MFG/PART NO.	TGS/CCMM 32K768A20-12.5-40-70T LF		
PART CODE	YR32K76800S001		

VENDOR APPROVE

Issued/Checked/Approved







DATE: July 17, 2024

CUSTOMER APPROVE		
DATE:		



KHZ SMD CRYSTALS 3215 TYPE YR SERIES

MAIN FEATURE

- SMD Package, L3.2*w1.5*h0.9mm, 2 Pads
- Industry Standard
- Reflow Profile Condition 260 °C Max.
- Cross More Competitors Part
- REACH/RoHS III Compliant





APPLICATION

· Small Communications Devices And More

HOW TO ORDER

Please follow up Part Code Guide and Indicate Part Code When You Order Or RFQ.

PART CODE GUIDE



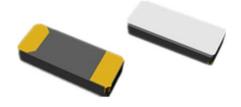
YR	32K76800	S	001
1	2	3	4

- 1. YR: Part family Code for KHz SMD crystal L3.2*W1.5*H0.9mm, 2 Pads
- 2. 32K76800: Frequency Range Code For 32.76800KHz
- 3. S: SMD type, Package Tape/Reel, 3000pcs/Reel
- 4. 001: Internal Control Code and Special Parameters Code Letter A~Z, a~z or digits (0-9)

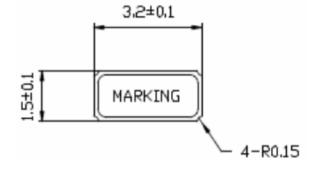
KHZ SMD CRYSTALS 3215 TYPE YR SERIES

DIMENSION (Unit: mm)

Image for reference



Top View



Marking

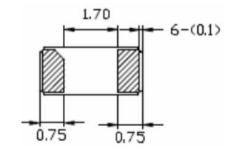
Frequency Range

or

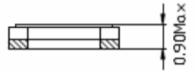
Marking

Internal Control Code

Bottom View

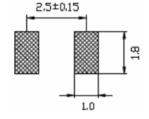


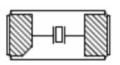
Side View





Land Pattern for reference

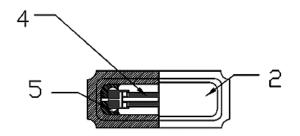


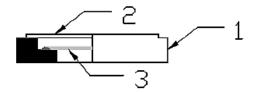




KHZ SMD CRYSTALS 3215 TYPE YR SERIES

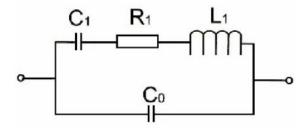
PRODUCT STRUCTURE





Component Material Item No. Name Name Crystal Case Ceramic 1 (A1203) 2 Crystal KV (Fe/Co/Ni) Cover/Lid 3 Crystal SiO2 Chip/Blank 4 Electrode Cr、Au (Cr+Au) 5 Adhesive Resin, Ag

EQUIVALENT CIRCUIT





KHZ SMD CRYSTALS 3215 TYPE YR SERIES

ELECTRICAL PARAMETERS – FOR DIFFERENT PART CODE- Ta = 25°C

Part Code	Frequency Range	Frequency Tolerance @ 25°C±3°C	Load Capacitance
	KHz	ppm	pF
YR32K76800S001	32.768	±20	12.5
YR32K76800S003	32.768	±20	7
YR32K76800S004	32.768	±20	6
YR32K76800S005	32.768	±20	9

GENERAL ELECTRICAL PARAMETERS

PARAMETER	UNITS	VALUE			CONDITION
		MIN.	TYPICAL	MAX.	
Mode of Oscillation		,	AT Fundamen	tal	
Equivalent Series Resistance (ESR)	ΚΩ	-	-	70	
Parabolic Coefficient	ppm/°C²	-0.04	-	-0.02	
Drive Level (DL)	μW	-	0.1	0.5	
Shunt Capacitance (C0)	pF	-	1.1	2.0	
Dynamic Capacitance (C1)	fF	-	4.1	-	
Turnover Temperance	°C	+20	25	+30	
Insulation Resistance	ΜΩ	500			@100VDC, ± 15VDC
Quality Factor (Q)	К	13	-	-	
Operation Temperance	°C	-40	-	+85	
Storage Temperance	°C	-55	-	+125	
Aging	ppm	-3	-	+3	Per Year



KHZ SMD CRYSTALS 3215 TYPE YR SERIES

RELIABILITY

TEST ITEMS	TEST METHOD AND CONDITIONS	TEST STANDARD
High Temperature High Humidity Storage	Temperature: 60°C ± 2 °C Relative Humidity: 90%~95% RH For Time: 500 ± 12 Hours	A, C, D, G
High Temperature Storage	Temperature: 125°C ± 2°C Time: 1000±12 Hours.	В, С, G
Low Temperature Storage	Temperature: $-40^{\circ}\text{C} \pm 2^{\circ}\text{C}$ Time: 500 ± 12 Hours.	A, C, G
Temperature Cycle	The crystal unit shall be subjected to 100 successive change of temperature cycles. $ +25\pm2^{\circ}C $ $ +25\pm2^{\circ}C $ $ -40+0/-6^{\circ}C $ $ 30\pm3min $ $ 3min. max. $ $ 1 Cycle $	A, C, G
Solderability	The solder pot temperature is 260±5°C , dwell time 2±0.6sec	F
Drop Test	Height: 180 cm; Dropped Cycle: 3 cycles; Drop it on to a concrete board for 6 Directions (X,Y,Z), that should be 1 cycle	В, С
Vibration	Frequency Range: 10Hz ~ 55Hz Amplitude: 1.5mm±15%; Sweep time: 2~3 Minutes, 2 Hours in each direction, total 6 Hours	A, C
Leakage Test	Helium Bombing 5.0 ~5.5 Kgf/cm²; for 2 hours	Е



KHZ SMD CRYSTALS 3215 TYPE YR SERIES

RELIABILITY

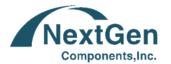
TEST ITEMS	TEST METHOD AND CONDITIONS	TEST STANDARD
Terminal Strength	Shall be pressurized at a speed of approx. 0.5mm/sec. in the direction indicated by the arrow unit the bending width reaches 3mm and held for 5 sec. PRESSURE ROD R20 R5 A5±2 A5±2 R5	B, C
Sticking Tendency	A R0.5 Jig shall be used to apply a 10N dead load in the direction indicated by the arrow to the element and retain it for 10 sec. JIG R0.5 SAMPLE	В, С
Element Assembly Strength	A RO.5 Jig shall be used to apply a 10N dead load in the direction indicated by the arrow to the element and retain it for 10 sec.	B, C



KHZ SMD CRYSTALS 3215 TYPE YR SERIES

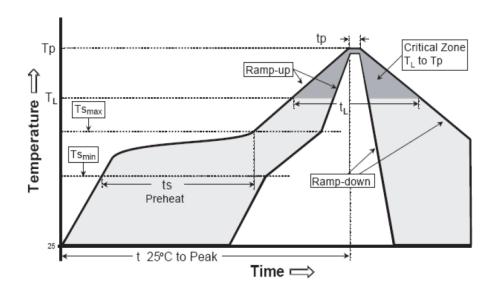
TEST STANDARD

TEST STANDARD SYMBOL	SPECIFICATION	VALUE
А	Frequency Change permitted	ΔF≤10ppm
В	Frequency Change permitted	ΔF≤20ppm
С	Equivalent Series Resistance Change Permitted	ΔCI≤5KΩ or 20%
D	Insulation Resistance	>500 MΩ
Е	Leak Rate Less than	<1*1E-9 Pa·m³/sec.
F	A new uniform coating of solder shall cover a Min 95% of the crystal surface	
G	Then 25 ± 2°C over 2 hours before Testing	



KHZ SMD CRYSTALS 3215 TYPE YR SERIES

SUGGESTED REFLOW PROFILE (For Reference No. JEDEC J-STD-020D)

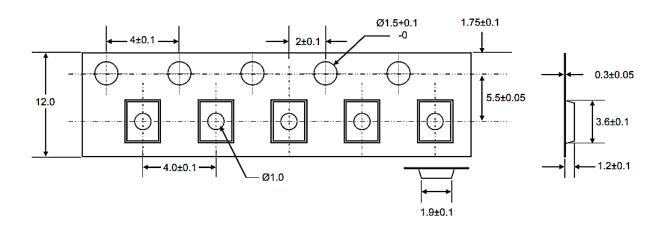


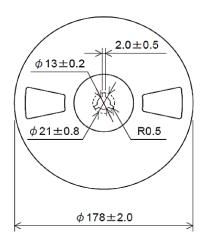
PROFILE FEATURE		PB-FREE ASSEMBLY
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max
Preheat	Temperature Min (Ts Min.)	150°C
	Temperature Max (Ts Max.)	200°C
	Time (ts Min. to ts Max.)	60 ~ 120 seconds
Time maintained above	Temperature (TL)	217°C
	Time (tL)	60 ~ 150 seconds
Peak/Classification Temperature (Tp)		260 +/-5°C
Time within 5°C of actual Peak Temperature (tp)		20 ~ 40 seconds
Ramp-down rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 minutes Max.
Suggest reflow times		3 Times Max.

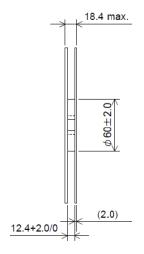
KHZ SMD CRYSTALS 3215 TYPE YR SERIES

REEL AND TAPE DIMENSION (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-2 and specifications, 3000pcs/Reel







7/17/2024 10



KHZ SMD CRYSTALS 3215 TYPE YR SERIES

NOTES BEFORE USE

Ultrasonic Cleaning

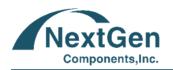
General cleaning solutions or ultrasonic cleaning method may be used to clean our products. However, under certain circumstances, ultrasonic cleaning machine could generate resonance at the oscillation frequency of our products and thus deteriorate the electrical characteristics in device and even damage the overall structure of device. Therefore, verification test is recommended before cleaning.

Ultrasonic Welding

Avoid mounting and processing by Ultrasonic welding this method has a possibility of an excessive vibration spreading inside the crystal products and become the cause of characteristic deterioration and not oscillating.

Storage Temperature Description

Storage Temperature is only for the product itself, the temperature for the packing material is 5~40°C Recommended Conditions for Manual Welding Max. Temperature: 350±10°C, Time: 3 sec Max., Re-solder time: twice Max.



KHZ SMD CRYSTALS 3215 TYPE YR SERIES

IMPORTANT NOTES AND DISCLAIMER

- ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum
 concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an
 exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for
 this product can be obtained can be obtained at Download Center.
- REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product.
 Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained can be obtained at Download Center.
- All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test
 conditions, unless otherwise noted. Product performance may not be indicated by the Electrical
 Characteristics if operated under different conditions.
- 4. NextGen Component, Inc (*NextGen*) reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.
- 5. NextGen makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, not does NextGen assume any liability for application assistance or customer product design.
- 6. NextGen does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application. No license is granted by implication or otherwise under any intellectual property rights of NextGen.
- NextGen products are not authorized for use as critical components in life support devices or systems without
 express written approval by NextGen.
- 8. NextGen requires that customers first obtain an RMA (Returned Merchandise Authorization) number prior to returning any products. Returns must be made within 30 days of the date of invoice, be in the original packaging, unused and like-new condition. At the time of quoting or purchasing, a product may say that it is

Non-Cancelable/ Non-Returnable (NCNR). These products are not returnable and not refundable.